Tyrone Camarero Specifications

Camarero-SDI200C3R-48

Key Feature

- Dual Socket E (LGA-4677) 4th Gen Intel® Xeon® Scalable processors, supports up to **300W TDP**
- Intel® C741
- 16 DIMM slots, Up to 4TB DDR5-4800MHz ECC Registered RDIMM
- 4 PCle 5.0 x16 full height slot(s), 2 PCle 5.0 x8 full height slot(s)
- 2x 1GbE port(s) /2x 10GbE port(s)
- 8x 3.5" hot-swap SATA3 drive bays , 2 M.2 NVMe
- 2 M.2 NVMe"
- 2 rear Fan(s), 3 middle Fan(s)
- 1200W Redundant Titanium Level power supplies





Processor/Cache

Dual Socket E (LGA-4677) 4th Gen Intel® **Processor**

Xeon® Scalable processors, supports up to

300W TDP

System Memory

Memory Capacity 16 DIMM slots, Up to 4TB DDR5-4800MHz

ECC Registered RDIMM

Chipset

Chipset Intel C741® Chipset

Expansion Slot

4 PCle 5.0 x16 full height slot(s), 2 PCle 5.0 **PCI-Express**

x8 full height slot(s)

Integrated Onboard:

SATA SATA3 (6Gbps)

Network Connectivity

2x 1GbE port(s) / 2x 10GbE port(s)

Add-on Options

Raid Card: Optional Optical

Drive:

Optional

Drive bays

HDD Bays 8x 3.5" hot-swap SATA3 drive bays, 2

M.2 NVMe

Periphheral

Bays

3x 5.25" DVD drive bays (optional)

Power Supply

Power Supply 1200W Redundant Titanium level

Power Supplies

Cooling System

2 rear Fan(s), 3 middle Fan(s) **Fans**

Form Factor

Form Factor 4U Rackmount

Dimensions

Dimensions "Dimensions: Height:17.8"" (452mm),

Width: 7"" (178mm), Depth: 25.5""

(647mm)"

Email: Info@tyronesystems.com For more/current product information, Visit www.tyronesystems.com

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